



219.40232X00

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Sarah KIM et al.

Serial No.: 10/077,967

Filed: February 20, 2002

For: A PROCESS OF VERTICALLY STACKING MULTIPLE
WAFERS SUPPORTING DIFFERENT ACTIVE INTEGRATED
CIRCUIT (IC) DEVICES

Art Unit: 2822

Examiner: Michael M. Trinh

2822
#6
RECEIVED
JUN 26 2003
TO 2800 MAIL ROOM

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

June 25, 2003

Sir:

In response to the Restriction Requirement (Paper No. 5) dated on June 18, 2003, Applicants hereby elect, without traverse, Group II (claims 1-18).

REMARKS

Claims 1-32 are pending in this application.

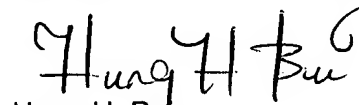
In response to the restriction requirement (Paper No. 5), in which the Examiner indicates that two groups of inventions are being claimed; namely Group I (claims 19-32) drawn to a 3-D vertical stacked wafer system, allegedly classified in class 257, subclass 773 and Group II (claims 1-18) drawn to a method of forming a vertical stacking wafers, allegedly classified in class 438, subclass 107, Applicants respectfully elect, without traverse, the invention of Group II directed to claims 1-18. Non-elected

Group I, drawn to claims 19-32, will be reinstated in a divisional application in due course.

To the extent necessary, applicants petition for an extension of time under 37 C.F.R. §1.136. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. 01-2135 of Antonelli, Terry, Stout & Kraus, LLP (referencing Attorney Docket No. 219.40232X00), and please credit any overpayment of fees to such deposit account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

A handwritten signature in black ink, appearing to read "Hung H. Bui". The signature is stylized with a large "H" and a long horizontal stroke.

Hung H. Bui
Reg. No. 40,415

(703) 312-6600
HHB